KEMET Part Number: C1206C330JBGACTU

(C1206C330JBGAC7800)



SMD Comm COG HV, Ceramic, 33 pF, 5%, 630 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206



Dimensions		
Chip Size	1206	
L	3.2mm +/-0.2mm	
W	1.6mm +/-0.2mm	
Т	1mm +/-0.10mm	
В	0.5mm +/-0.25mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Plastic Tape	
Packaging Quantity:	2500	

General Information	
Series:	SMD Comm C0G HV
Style:	SMD Chip
Description:	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features:	Ultra-Stable, Low Loss, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Component Weight:	25 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications		
Capacitance:	33 pF	
Measurement Condition:	1 MHz 1.0Vrms	
Capacitance Tolerance:	5%	
Voltage DC:	630 VDC	
Dielectric Withstanding Voltage:	945 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor:	0.1% 1 MHz 1.0Vrms	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	100 GOhms	

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